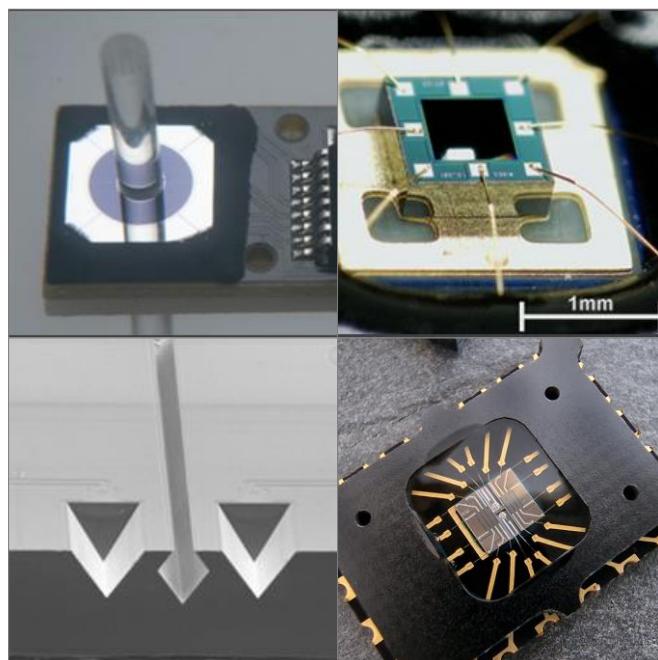


# Customized Photo Diodes

## APPLICATION

Photo diodes and -arrays allow numerous sensing applications in almost any field:

- Medical & life science (vital parameters, diagnostics, laboratory systems, micro fluidics ...)
- Industrial & safety (particles, color, speed, optical density, fluorescence, optical encoders ...)
- Consumer devices (vital parameters, consumer electronics, ...)
- Automotive & Telecom (fiber communication, LIDAR, speed, ...)



## FULL FREEDOM IN (3D) DESIGN

With an in-house silicon wafer manufacturing, CIS offers full freedom in photo diodes design - even in 3D.

PARAMETER	VALUE / RANGE
Chip size	~1 $\mu\text{m}^2$ ... 100 $\text{cm}^2$
Chip Thickness	200 ... 900 $\mu\text{m}$
Spectral Response	200 ... 1100 nm
Dynamics	DC to GHz
Shape of Chip Edges	Any
Segments	1 ... x1000
Specialities	<ul style="list-style-type: none"><li>• In plane and through silicon fibre coupling</li><li>• Tilted active areas</li><li>• Through silicon vias</li><li>• Hermetic sealing</li><li>• Any housing or substrate</li><li>• ...</li></ul>



CiS Forschungsinstitut für Mikrosensorik GmbH  
Konrad-Zuse-Str. 14, 99099 Erfurt, Germany

Dr. Martin Schädel  
+49 361 663 1426  
mschaedel@cismst.de  
www.cismst.de

All rights reserved, in particular the right of reproduction and distribution and translation.